Loctite 3621 Chipbonder Surface Mount Adhesives

Product Images



Description

Loctite 3621 is particularly suited where dispense speeds greater than 35,000 dots/h are required. Designed for bonding of surface mounted devices to printed circuit boards, Loctite 3621 has been used successfully in lead free processes

- Dispense method syringe
- SMD components to PCB
- Dispense speed very high (25,000 50,000 dots/h)
- One component
- Appearance when uncured red viscous gel
- Chemical type epoxy
- Wet strength high

